



# THE DATASHEET OF SDT10S60



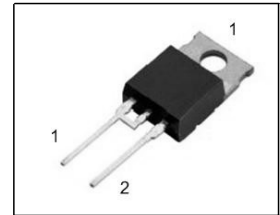
**Silicon Carbide Schottky Diode**

- Worlds first 600V Schottky diode
- Revolutionary semiconductor material - Silicon Carbide
- Switching behavior benchmark
- No reverse recovery
- No temperature influence on the switching behavior
- No forward recovery
- Pb-free lead plating; RoHS compliant
- Qualified according to JEDEC<sup>0)</sup> for target applications

**thinQ!<sup>TM</sup> SiC Schottky Diode**
**Product Summary**

$V_{RRM}$	600	V
$Q_C$	29	nC
$I_F$	10	A

PG-TO220-2-2.



Type	Package	Ordering Code	Marking	Pin 1	Pin 2
SDT10S60	PG-TO220-2-2.	Q67040S4643	D10S60	C	A

**Maximum Ratings, at  $T_j = 25^\circ\text{C}$ , unless otherwise specified**

Parameter	Symbol	Value	Unit
Continuous forward current, $T_C=100^\circ\text{C}$	$I_F$	10	A
RMS forward current, $f=50\text{Hz}$	$I_{FRMS}$	14.1	
Surge non repetitive forward current, sine halfwave $T_C=25^\circ\text{C}$ , $t_p=10\text{ms}$	$I_{FSM}$	31	
Repetitive peak forward current $T_j=150^\circ\text{C}$ , $T_C=100^\circ\text{C}$ , $D=0.1$	$I_{FRM}$	39	
Non repetitive peak forward current $t_p=10\mu\text{s}$ , $T_C=25^\circ\text{C}$	$I_{FMAX}$	100	
$i^2t$ value, $T_C=25^\circ\text{C}$ , $t_p=10\text{ms}$	$\int i^2 dt$	4.8	A <sup>2</sup> s
Repetitive peak reverse voltage	$V_{RRM}$	600	V
Surge peak reverse voltage	$V_{RSM}$	600	
Power dissipation, $T_C=25^\circ\text{C}$	$P_{tot}$	75	W
Operating and storage temperature	$T_j, T_{stg}$	-55... +175	$^\circ\text{C}$

<sup>0)</sup>J-STD20 and JESD22

**Thermal Characteristics**

Parameter	Symbol	Values			Unit
		min.	typ.	max.	
<b>Characteristics</b>					
Thermal resistance, junction - case	$R_{thJC}$	-	-	2	K/W
Thermal resistance, junction - ambient, leaded	$R_{thJA}$	-	-	62	

**Electrical Characteristics, at  $T_j = 25^\circ\text{C}$ , unless otherwise specified**

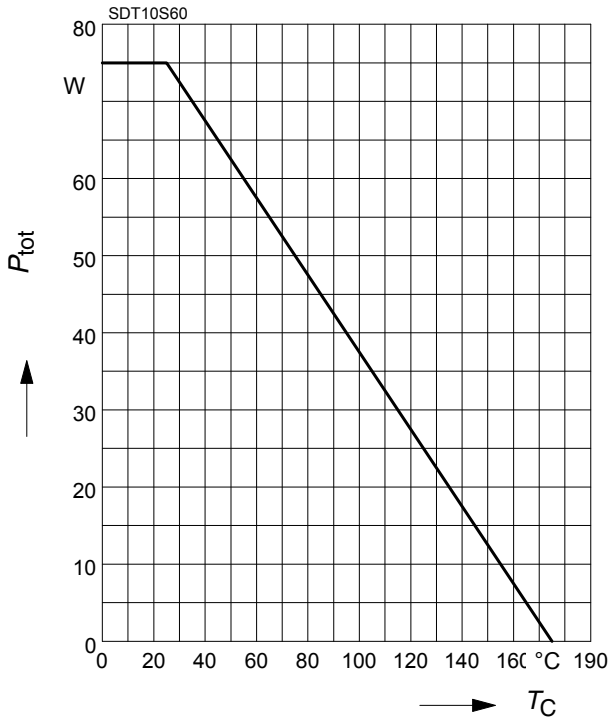
Parameter	Symbol	Values			Unit
		min.	typ.	max.	
<b>Static Characteristics</b>					
Diode forward voltage	$V_F$	-	1.5	1.7	V
$I_F=10\text{A}, T_j=25^\circ\text{C}$					
$I_F=10\text{A}, T_j=150^\circ\text{C}$		-	1.7	2.1	
Reverse current	$I_R$	-	34	350	$\mu\text{A}$
$V_R=600\text{V}, T_j=25^\circ\text{C}$					
$V_R=600\text{V}, T_j=150^\circ\text{C}$					

**Electrical Characteristics, at  $T_j = 25\text{ °C}$ , unless otherwise specified**

Parameter	Symbol	Values			Unit
		min.	typ.	max.	
<b>AC Characteristics</b>					
Total capacitive charge $V_R=400\text{V}$ , $I_F=10\text{A}$ , $di_F/dt=200\text{A}/\mu\text{s}$ , $T_j=150\text{°C}$	$Q_C$	-	29	-	nC
Switching time $V_R=400\text{V}$ , $I_F=10\text{A}$ , $di_F/dt=200\text{A}/\mu\text{s}$ , $T_j=150\text{°C}$	$t_{rr}$	-	n.a.	-	ns
Total capacitance $V_R=0\text{V}$ , $T_C=25\text{°C}$ , $f=1\text{MHz}$ $V_R=300\text{V}$ , $T_C=25\text{°C}$ , $f=1\text{MHz}$ $V_R=600\text{V}$ , $T_C=25\text{°C}$ , $f=1\text{MHz}$	$C$	-	350 33 23	-	pF

**1 Power dissipation**

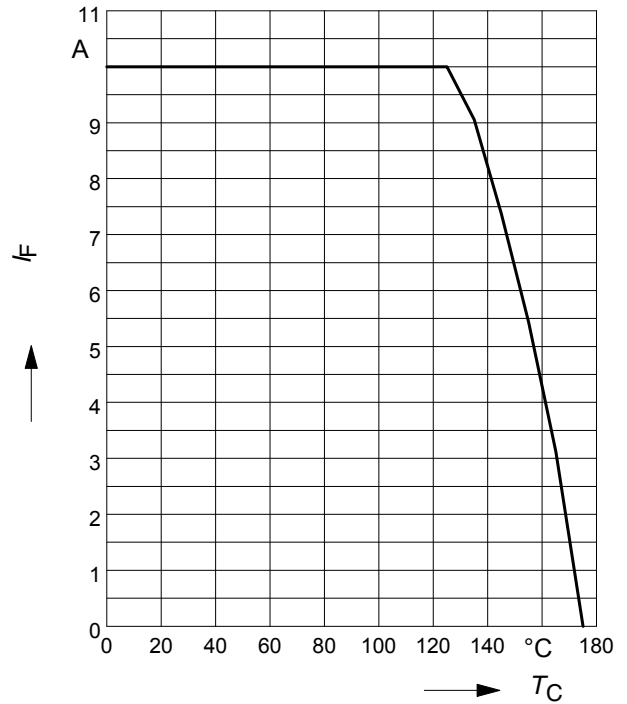
$P_{tot} = f(T_C)$



**2 Diode forward current**

$I_F = f(T_C)$

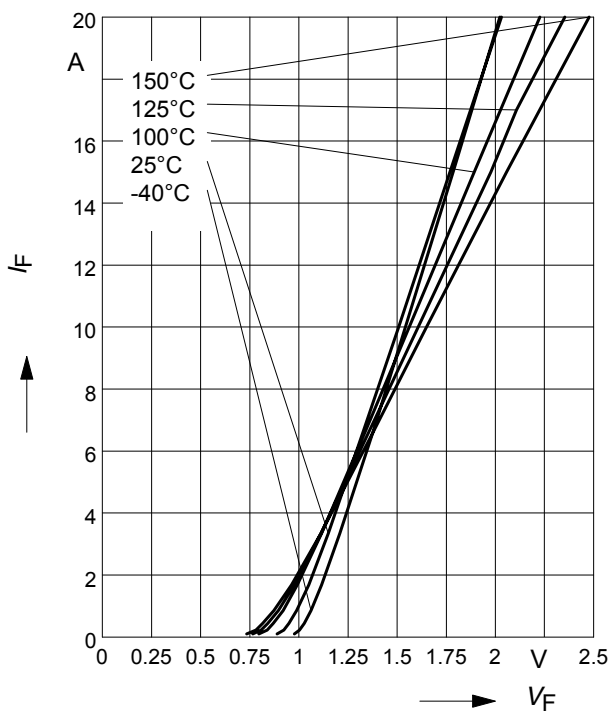
parameter:  $T_j \leq 175^\circ\text{C}$



**3 Typ. forward characteristic**

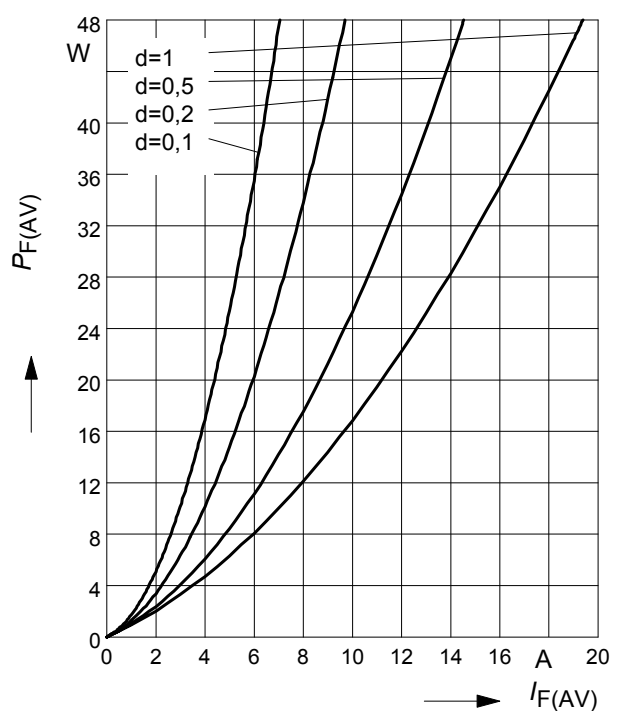
$I_F = f(V_F)$

parameter:  $T_j$ ,  $t_p = 350 \mu\text{s}$



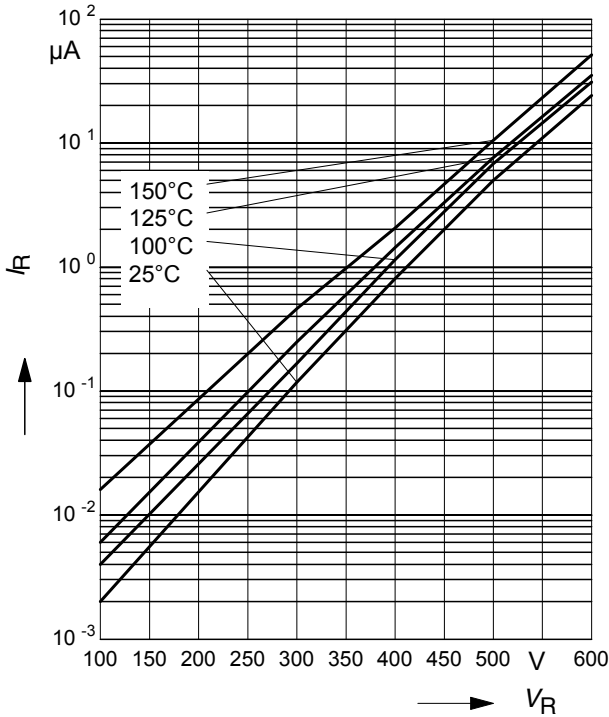
**4 Typ. forward power dissipation vs. average forward current**

$P_{F(AV)} = f(I_F)$   $T_C = 100^\circ\text{C}$ ,  $d = t_p/T$



**5 Typ. reverse current vs. reverse voltage**

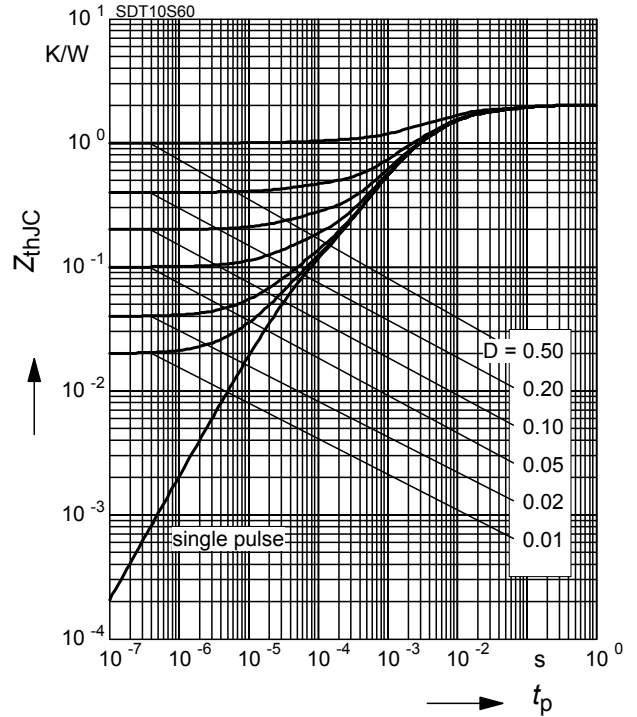
$$I_R = f(V_R)$$



**6 Transient thermal impedance**

$$Z_{thJC} = f(t_p)$$

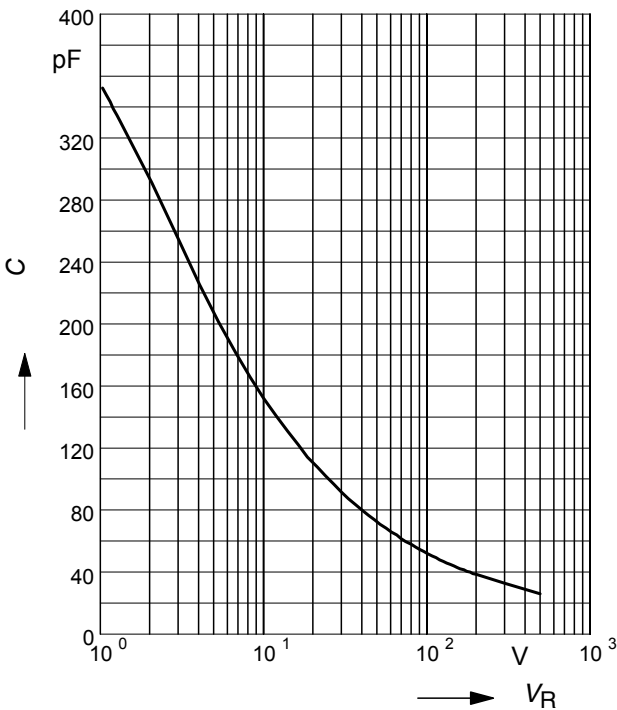
parameter :  $D = t_p/T$



**7 Typ. capacitance vs. reverse voltage**

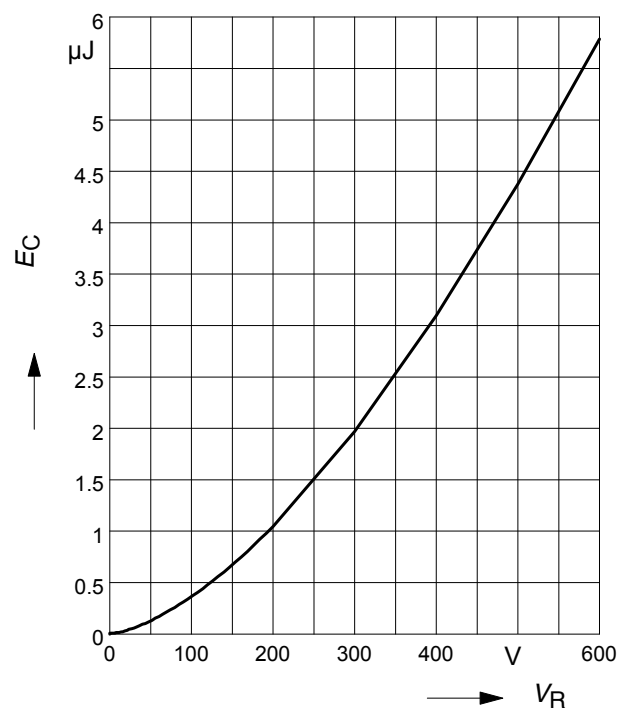
$$C = f(V_R)$$

parameter:  $T_C = 25^\circ\text{C}$ ,  $f = 1\text{ MHz}$



**8 Typ. C stored energy**

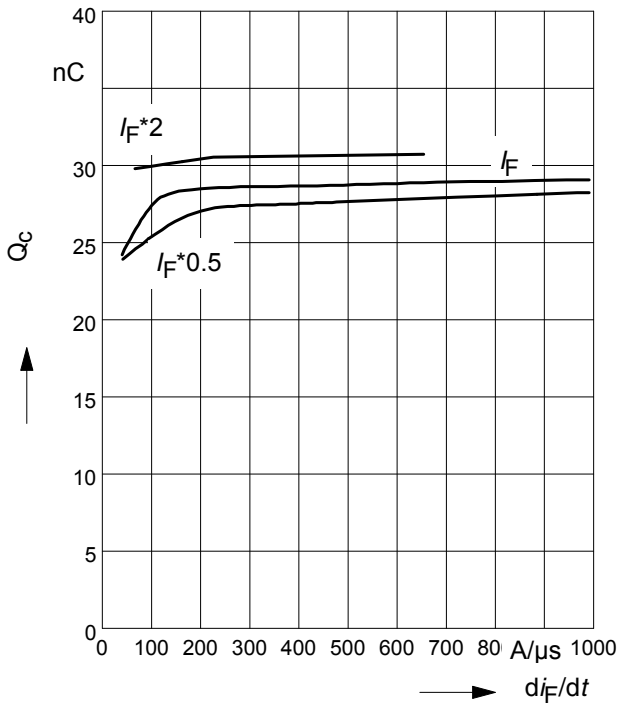
$$E_C = f(V_R)$$



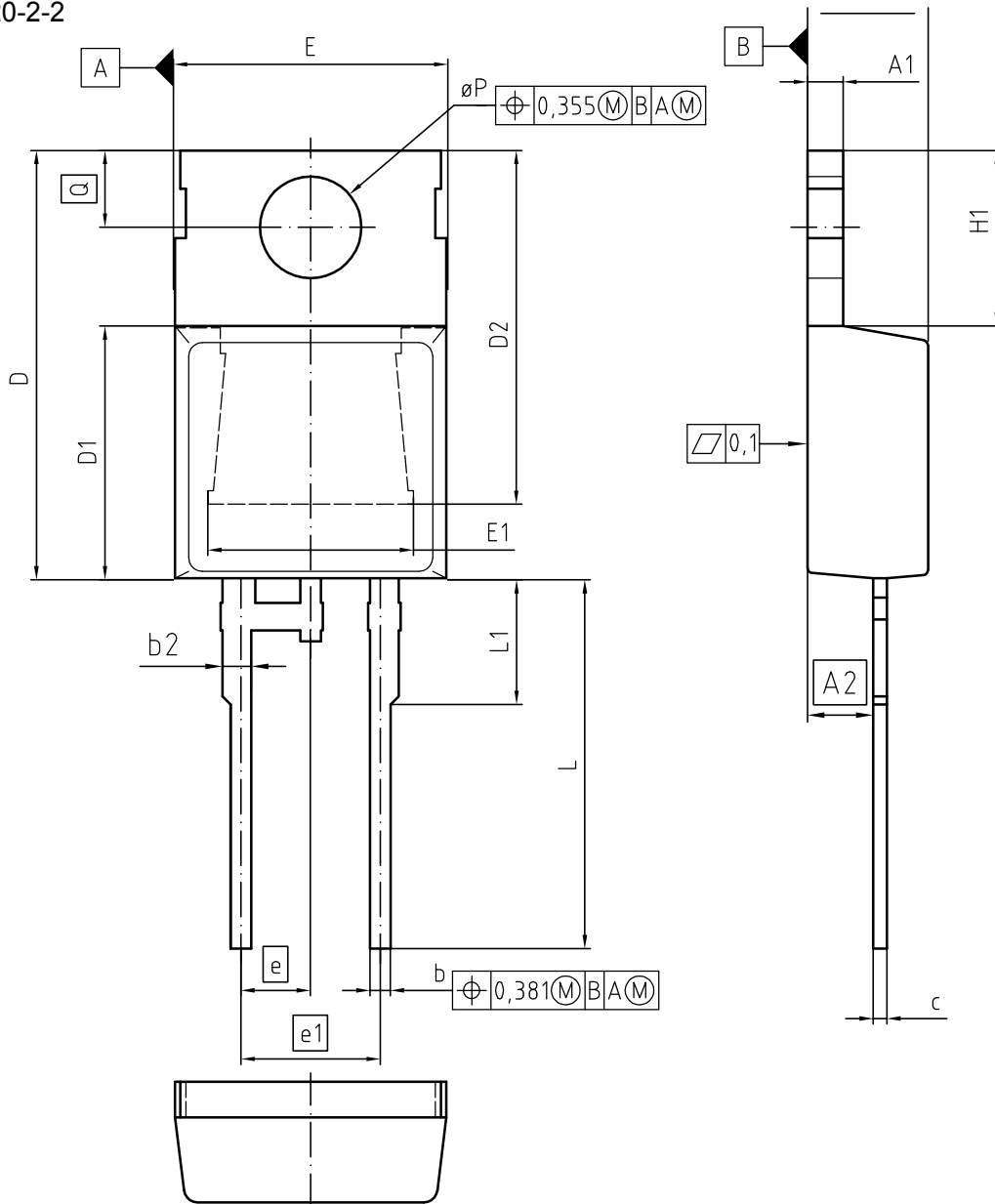
9 Typ. capacitive charge vs. current slope

$$Q_C = f(dI_F/dt)$$

parameter:  $T_j = 150\text{ }^\circ\text{C}$



PG-TO-220-2-2



DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	4.191	4.699	0.165	0.185
A1	1.170	1.400	0.046	0.055
A2	2.215	2.718	0.087	0.107
b	0.635	0.889	0.025	0.035
b2	0.950	1.651	0.037	0.065
c	0.330	0.635	0.013	0.025
D	14.808	15.950	0.583	0.628
D1	8.509	9.450	0.335	0.372
D2	12.850	14.245	0.506	0.561
E	9.677	10.363	0.381	0.408
E1	6.500	8.788	0.256	0.346
e	2.540		0.100	
e1	5.080		0.200	
N	2		2	
H1	5.900	6.900	0.232	0.272
L	12.700	14.000	0.500	0.551
L1	3.048	4.800	0.120	0.189
øP	3.550	3.886	0.140	0.153
Q	2.540	3.048	0.100	0.120

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